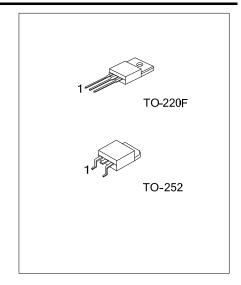
UNISONIC TECHNOLOGIES CO., LTD

3N60A **Power MOSFET**

3A, 600V **N-CHANNEL POWER MOSFET**

DESCRIPTION

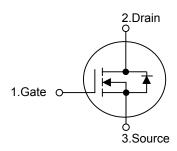
The UTC 3N60A is a high voltage and high current power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used in the high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



FEATURES

- * $V_{DS} = 600V$, $I_{D} = 3A$
- * $R_{DS(ON)}$ = 3.6 Ω @ V_{GS} = 10 V
- * Ultra low gate charge (typical 10 nC)
- * Low reverse transfer capacitance (C_{RSS} = typical 5.5 pF)
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

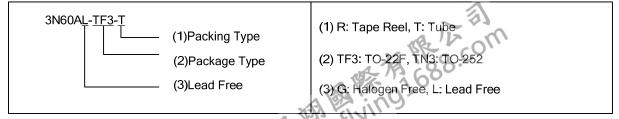
SYMBOL



ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N60AL-TF3-T	3N60AG-TF3-T	TO-220F	G	D	S	Tube	
3N60AL-TN3-R	3N60AG-TN3-R	TO-252	G	D	S	Tape Reel	
3N60AL-TN3-T	3N60AG-TN3-T	TO-252	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	600	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	3.0	Α	
Continuous Drain Current		I _D	3.0	Α	
Pulsed Drain Current (Note 2)		I _{DM}	12	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	200	mJ	
	Repetitive (Note 2)	E _{AR}	7.5	mJ	
Peak Diode Recovery dv/dt (Note	e 4)	dv/dt	4.5	V/ns	
Dower Dissipation	TO-220F	Ь	34	W	
Power Dissipation	TO-252	- P _D	50		
Junction Temperature		TJ	+150	$^{\circ}\!\mathbb{C}$	
Operating Temperature		T _{OPR}	-55 ~ +150	$^{\circ}$ C	
Storage Temperature		T _{STG}	-55 ~ +150	$^{\circ}\!\mathbb{C}$	

- Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 - 2. Repetitive Rating: Pulse width limited by maximum junction temperature
 - 3. L = 64mH, I_{AS} = 2.4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
 - 4. $I_{SD} \le 3.0 \text{A}$, di/dt $\le 200 \text{A}/\mu\text{s}$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	TO-220F	0	62.5	°C/W	
Junction to Ambient	TO-252	θ _{JA}	110		
lunction to Coop	TO-220F	0	3.68	°C/W	
Junction to Case	TO-252	θ_{JC}	2.5		



ELECTRICAL CHARACTERISTICS (T_C =25°C, unless otherwise specified)

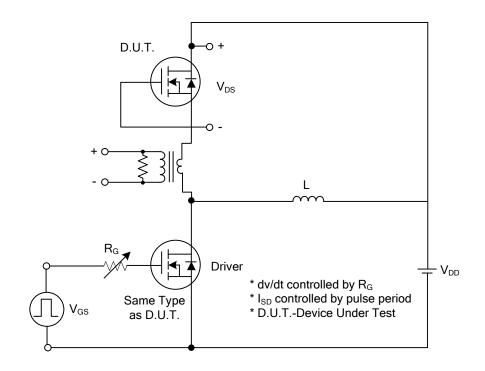
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS				•			•
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	600			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V			10	μΑ
Gate-Source Leakage Current	Forward	000	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
	Reverse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
Breakdown Voltage Temperature		I/\BVpcc//\Li	$I_D = 250 \mu A$,		0.6		V/°C
Coefficient			Referenced to 25°C		0.6		V/ C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{A}$		2.8	3.6	Ω
DYNAMIC CHARACTERISTICS							_
Input Capacitance		C _{ISS}	V _{DS} = 25 V, V _{GS} = 0 V,		350	450	pF
Output Capacitance		Coss	f = 1MHz		50	65	pF
Reverse Transfer Capacitance		C _{RSS}	1 - 1101112		5.5	7.5	pF
SWITCHING CHARACTERISTIC	S						_
Turn-On Delay Time Turn-On Rise Time		t _{D(ON)}	$V_{DD} = 300V, I_{D} = 3.0 A,$ $R_{G} = 25\Omega$		10	30	ns
		t _R			30	70	ns
Turn-Off Delay Time		t _{D(OFF)}	(Note 1, 2)		20	50	ns
Turn-Off Fall Time		t _F	(14010-1, 2)		30	70	ns
Total Gate Charge Gate-Source Charge Gate-Drain Charge		Q_{G}	V _{DS} = 480V,I _D = 3.0A, V _{GS} = 10 V (Note 1, 2)		10	13	nC
		Q_GS			2.7		nC
		Q_{DD}	VGS= 10 V (Note 1, 2)		4.9		nC
SOURCE- DRAIN DIODE RATING	GS AND (CHARACTERI	STICS				
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A}$			1.4	V
Maximum Continuous Drain-Source	ce Diode	I-				3.0	Α
Forward Current		I _S				3.0	А
Maximum Pulsed Drain-Source Diode		I _{SM}				12	Α
Forward Current						14	
Reverse Recovery Time			$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A},$		210		ns
Reverse Recovery Charge		Q_{RR}	dI _F /dt = 100 A/μs (Note 1)		1.2		μC

Notes: 1. Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

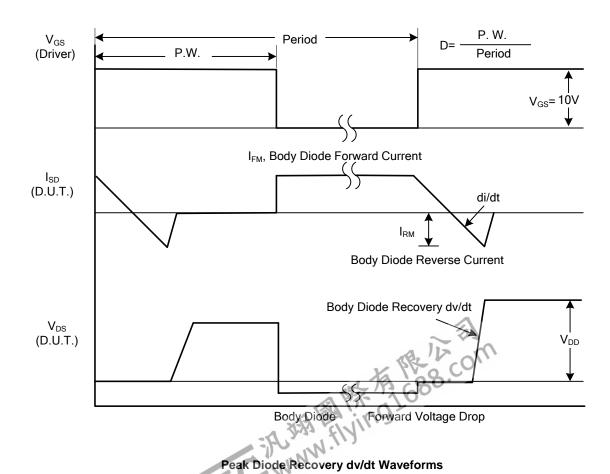
2. Essentially independent of operating temperature.



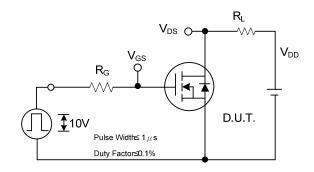
TEST CIRCUITS AND WAVEFORMS

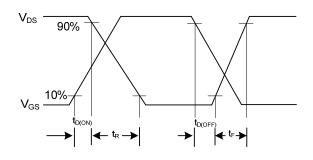


Peak Diode Recovery dv/dt Test Circuit



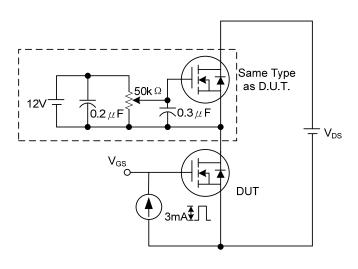
TEST CIRCUITS AND WAVEFORMS (Cont.)

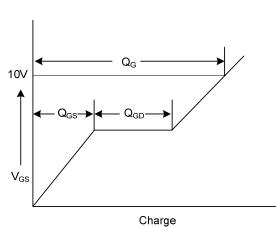




Switching Test Circuit

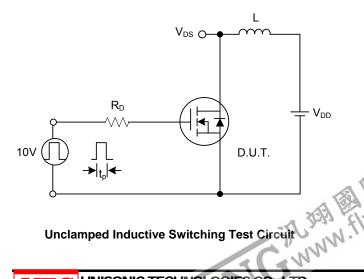
Switching Waveforms

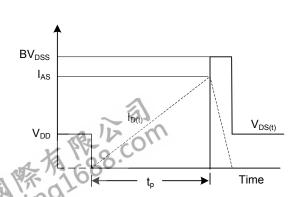




Gate Charge Test Circuit

Gate Charge Waveform

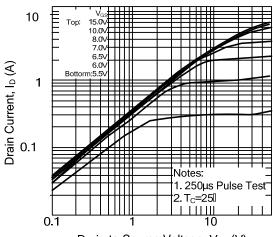




Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS

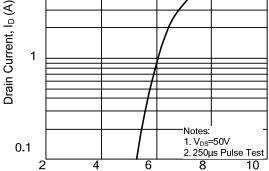




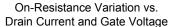
Drain-to-Source Voltage, V_{DS} (V)

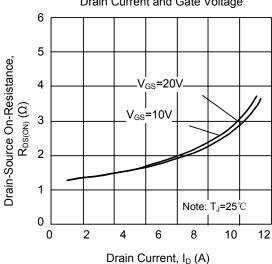
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Transfer Characteristics

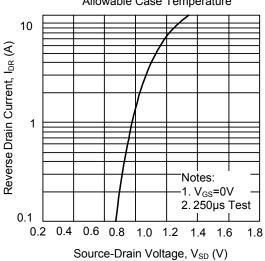


Gate-Source Voltage, V_{GS} (V)

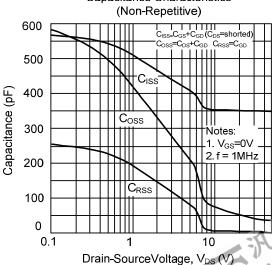




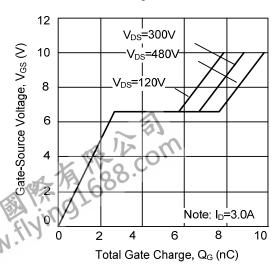
On State Current vs. Allowable Case Temperature



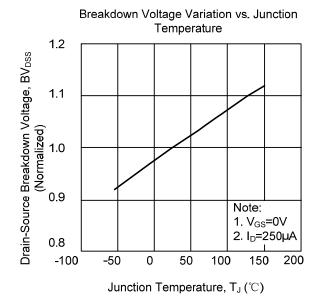
Capacitance Characteristics



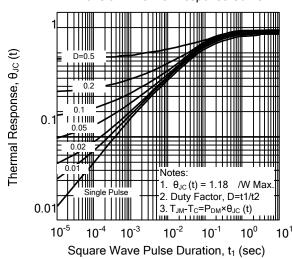
Gate Charge Characteristics



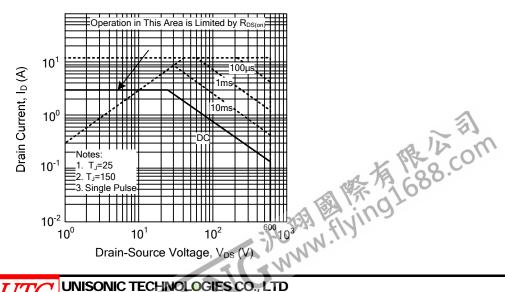
■ TYPICAL CHARACTERISTICS(Cont.)



Transient Thermal Response Curve



Safe Operating Area - 600V

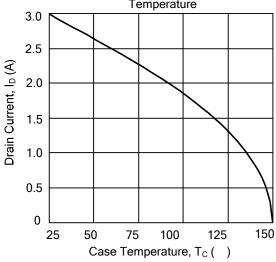


On-Resistance Variation vs. Junction Temperature 3.0 Drain-Source On-Resistance, R_{DS(ON)} 2.5 2.0 (Normalized) 1.5 1.0 Note: 0.5 1. V_{GS}=10\ 2. I_D=4A 0.0 -100 -50 50 100 150 200

Junction Temperature, T_J (°C)

Maximum Drain Current vs. Case

Temperature



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